2SD1474

Silicon NPN epitaxial planar type

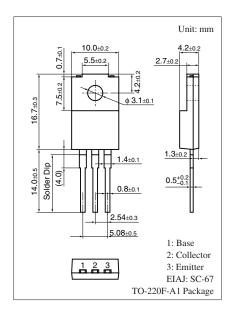
For power amplification with high forward current transfer ratio

■ Features

- \bullet High forward current transfer ratio $h_{F\!E}$ which has satisfactory linearity
- ullet High emitter-base voltage (Collector open) V_{EBO}
- Full-pack package which can be installed to the heat sink with one screw

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter		Symbol	Rating	Unit	
Collector-base voltage (Emitter open)		V_{CBO}	100	V	
Collector-emitter voltage (Base open)		V_{CEO}	60	V	
Emitter-base voltage (Collector open)		V_{EBO}	15	V	
Collector current		I_C	6	A	
Peak collector current		I_{CP}	12	A	
Collector power		P_{C}	40	W	
dissipation	$T_a = 25^{\circ}C$		2.0		
Junction temperature		T_j	150	°C	
Storage temperature		T_{stg}	-55 to +150	°C	



■ Electrical Characteristics $T_C = 25$ °C ± 3 °C

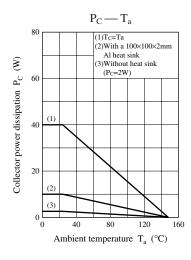
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_C = 25 \text{ mA}, I_B = 0$	60			V
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = 100 \text{ V}, I_{E} = 0$			100	μΑ
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 15 \text{ V}, I_C = 0$			100	μΑ
Forward current transfer ratio *	h_{FE}	$V_{CE} = 4 \text{ V}, I_{C} = 1 \text{ A}$	300		2000	_
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 5 \text{ A}, I_B = 0.1 \text{ A}$			0.5	V
Transition frequency	f_T	$V_{CE} = 12 \text{ V}, I_{C} = 0.5 \text{ A}, f = 10 \text{ MHz}$		30		MHz
Turn-on time	t _{on}	$I_C = 5 \text{ A}, I_{B1} = 0.1 \text{ A}, I_{B2} = -0.1 \text{ A}$		0.3		μs
Storage time	t _{stg}	$V_{CC} = 50 \text{ V}$		1.5		μs
Fall time	$t_{\rm f}$			0.6		μs

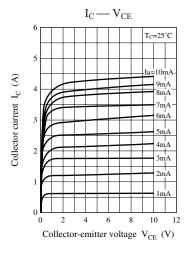
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

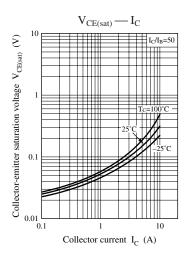
2. *: Rank classification

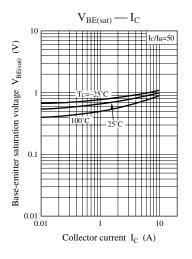
Rank	Q	Р		
h_{FE}	300 to 1 200	800 to 2000		

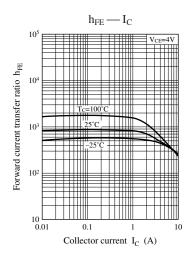
Panasonic

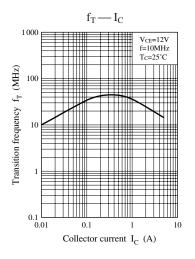


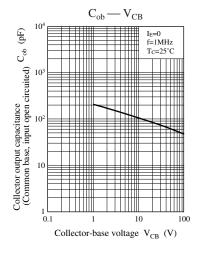


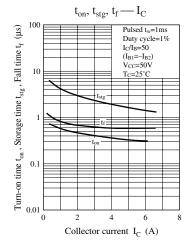


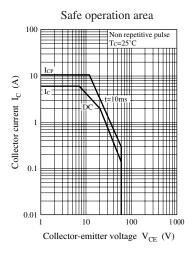




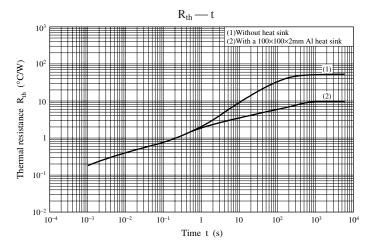








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